

SD12CT1

Transient Voltage Suppressor

Bi-directional ESD Protection with Ultra Low Clamping Voltage

The SD12C is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make this part ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications.

Specification Features:

- Peak Power – 350 W (8 × 20 μs)
- Low Leakage
- Low Clamping Voltage
- Small Package for use in Portable Electronics
- Meets IEC61000-4-2 Level 4
- Meets IEC6100-4-4 Level 4
- Meets 16 kV Human Body Model ESD Requirements
- Pb-Free Package is Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic
Epoxy Meets UL 94, V-0

MOUNTING POSITION: Any

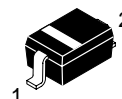
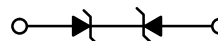
QUALIFIED MAX REFLOW TEMPERATURE: 260°C
Device Meets MSL 1 Requirements

Use the Device Number to order the 7 inch/3,000 unit reel.
Replace the “T1” with “T3” in the Device Number to order the 13 inch/10,000 unit reel.



ON Semiconductor®

<http://onsemi.com>



SOD-323
CASE 477
STYLE 1

MARKING DIAGRAM



ZK = Specific Device Code
M = Date Code

ORDERING INFORMATION

Device	Package	Shipping†
SD12CT1	SOD-323	3000 Tape & Reel
SD12CT1G	SOD-323 Pb-Free	3000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MAXIMUM RATINGS

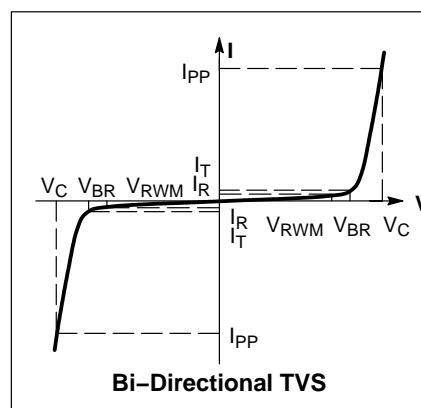
Rating	Symbol	Value	Unit
Peak Power Dissipation @ 20 μ s @ $T_L \leq 25^\circ\text{C}$	P_{pk}	350	W
IEC 61000-4-2 (ESD) Air Contact		± 30 ± 30	kV
IEC 61000-4-4 (EFT)		40	A
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$
Operating Temperature Range	T_J	-55 to +125	$^\circ\text{C}$
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	$^\circ\text{C}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
ΔV_{BR}	Maximum Temperature Variation of V_{BR}



ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

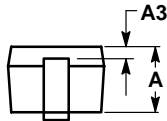
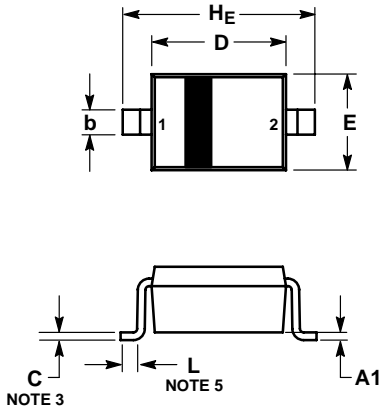
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	(Note 1)	V_{RWM}			12	V
Breakdown Voltage	$I_T = 1 \text{ mA}$, (Note 2)	V_{BR}	13.3			V
Reverse Leakage Current	$V_{RWM} = 12 \text{ V}$	I_R			1.0	μA
Clamping Voltage Additional Clamping Voltage	$I_{PP} = 5 \text{ A}$, (8 x 20 μsec Waveform) $I_{PP} = 15 \text{ A}$, (8 x 20 μsec Waveform)	V_C			19 24	V
Maximum Peak Pulse Current	8 x 20 μsec Waveform	I_{PP}			15	A
Capacitance	$V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$	C_j		64		pF
	$V_R = 12 \text{ V}$, $f = 1 \text{ MHz}$			36		

1. TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level.
2. V_{BR} is measured at pulse test current I_T .

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PACKAGE DIMENSIONS

SOD-323
CASE 477-02
ISSUE G



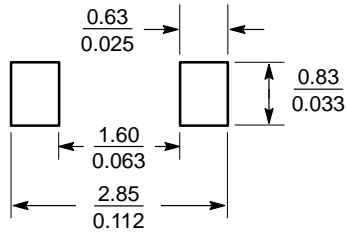
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DIMENSION L IS MEASURED FROM END OF RADIUS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.031	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.15 REF			0.006 REF		
b	0.25	0.32	0.4	0.010	0.012	0.016
C	0.089	0.12	0.177	0.003	0.005	0.007
D	1.60	1.70	1.80	0.062	0.066	0.070
E	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
HE	2.30	2.50	2.70	0.090	0.098	0.105

STYLE 1:
PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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